



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts,Customers Priority,Honest Operation,and Considerate Service",our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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1.TYPE US6J2

2.STRUCTURE SILICON P-CHANNEL MOS FET

3.APPLICATIONS SWITCHING

4.ABSOLUTE MAXIMUM RATINGS [Ta=25°C]
《 IT IS THE SAME RATINGS FOR THE Tr1 AND Tr2. 》DRAIN-SOURCE VOLTAGE V_{DSS} . . . -20VGATE-SOURCE VOLTAGE V_{GSS} . . . $\pm 12V$ DRAIN CURRENT CONTINUOUS I_D . . . $\pm 1A$ PULSED I_{DP} . . . $\pm 4A$ PW $\leq 10\mu s$ DUTY CYCLE $\leq 1\%$ SOURCE CURRENT CONTINUOUS I_S . . . -0.4A
(BODY DIODE)PULSED I_{SP} . . . -4A PW $\leq 10\mu s$ DUTY CYCLE $\leq 1\%$ TOTAL POWER DISSIPATION P_D . . . 1.0W / TOTAL
0.7W / ELEMENT
MOUNTED ON A CERAMIC BOARDCHANNEL TEMPERATURE T_{ch} . . . 150°CRANGE OF STRAGE TEMPERATURE T_{stg} . . . - 55 ~ 150°C

5.THERMAL RESISTANCE

CHANNEL TO AMBIENT $R_{th(ch-a)}$. . . 125°C/W / TOTAL
179°C/W / ELEMENT
MOUNTED ON A CERAMIC BOARD

DESIGN

CHECK

APPROVAL

DATE : 29/SEP/2003

SPECIFICATION No. TSQ03125-US6J2

REV. : 0

ROHM CO., LTD.

6.ELECTRICAL CHARACTERISTICS [Ta=25°C]

《 IT IS THE SAME CHARACTERISTICS FOR THE Tr1 AND Tr2 》

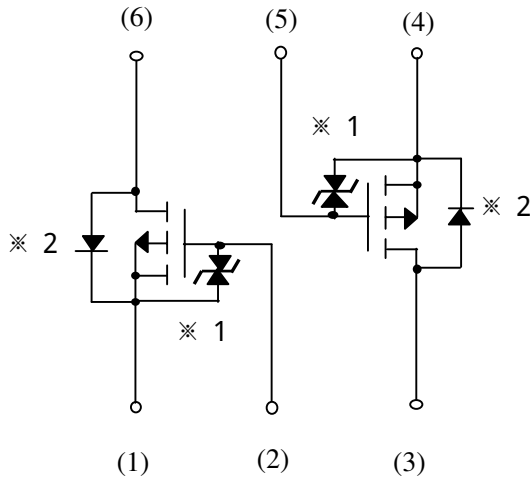
PARAMETER	ITEM	CONDITION	MIN.	TYP.	MAX.
GATE-SOURCE LEAKAGE	I_{GSS}	$V_{GS}=\pm 12V/V_{DS}=0V$	-	-	$\pm 10\mu A$
DRAIN-SOURCE BREAKDOWN VOLTAGE	$V_{(BR)DSS}$	$I_D=-1mA/V_{GS}=0V$	-20V	-	-
ZERO GATE VOLTAGE DRAIN CURRENT	I_{DSS}	$V_{DS}=-20V/V_{GS}=0V$	-	-	-1 μA
GATE THRESHOLD VOLTAGE	$V_{GS(th)}$	$V_{DS}=-10V/I_D=-1mA$	-0.7V	-	-2.0V
STATIC DRAIN-SOURCE ON-STATE RESISTANCE	$R_{DS(on)}$ * PULSED	$I_D=-1A/V_{GS}=-4.5V$	-	280m Ω	390m Ω
		$I_D=-1A/V_{GS}=-4V$	-	310m Ω	430m Ω
		$I_D=-0.5A/V_{GS}=-2.5V$	-	570m Ω	800m Ω
FORWARD TRANSFER ADMITTANCE	$ Y_{fs} $ * PULSED	$V_{DS}=-10V/I_D=-0.5A$	0.7S	-	-
INPUT CAPACITANCE	C_{iss}	$V_{DS}=-10V$ $V_{GS}=0V$ $f=1MHz$	-	150pF	-
OUTPUT CAPACITANCE	C_{oss}		-	20pF	-
REVERSE TRANSFER CAPACITANCE	C_{rss}		-	20pF	-
TURN-ON DELAY TIME	$t_{d(on)}$ * PULSED	$I_D=-0.5A$ $V_{DD} \approx -15V$ $V_{GS}=-4.5V$ $R_L \approx 30\Omega/R_G=10\Omega$ see Fig. 1-1,1-2	-	9ns	-
RISE TIME	t_r * PULSED		-	8ns	-
TURN-OFF DELAY TIME	$t_{d(off)}$ * PULSED		-	25ns	-
FALL TIME	t_f *PULSED		-	10ns	-
TOTAL GATE CHARGE	Q_g *PULSED	$V_{DD} \approx -15V$ $V_{GS}=-4.5V$ $I_D=-1A$ $R_L \approx 15\Omega/R_G=10\Omega$ see Fig. 2-1,2-2	-	2.1nC	-
GATE-SOURCE CHARGE	Q_{gs} *PULSED		-	0.5nC	-
GATE-DRAIN CHARGE	Q_{gd} *PULSED		-	0.5nC	-

BODY DIODE (SOURCE-DRAIN)

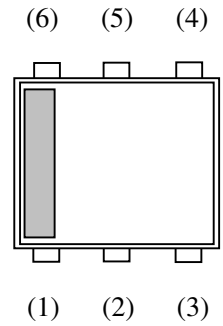
《 IT IS THE SAME CHARACTERISTICS FOR THE Tr1 AND Tr2 》

PARAMETER	ITEM	CONDITION	MIN.	TYP.	MAX.
FORWARD VOLTAGE	V_{SD}	$I_S=-0.4A / V_{GS}=0V$	-	-	-1.2V

7. INNER CIRCUIT

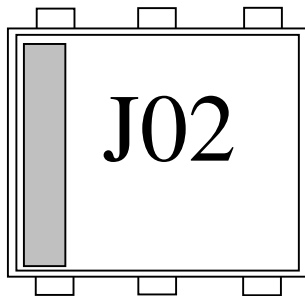


- (1) Tr1 SOURCE
- (2) Tr1 GATE
- (3) Tr2 DRAIN
- (4) Tr2 SOURCE
- (5) Tr2 GATE
- (6) Tr1 DRAIN



- * 1 ESD PROTECTION DIODE
- * 2 BODY DIODE

8. MARKING



“J02” MEANS US6J2.

9.MEASUREMENT CIRCUIT

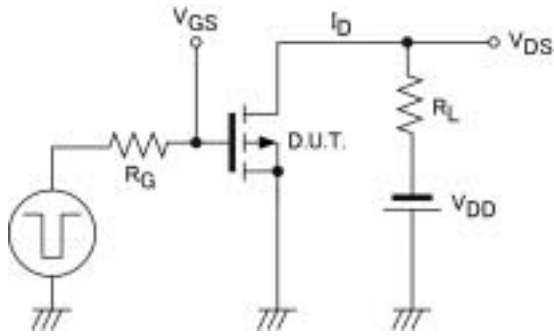


Fig.1-1 SWITCHING TIME MEASUREMENT CIRCUIT

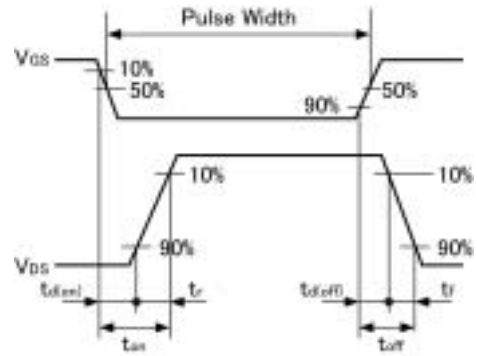


Fig.1-2 SWITCHING WAVEFORMS

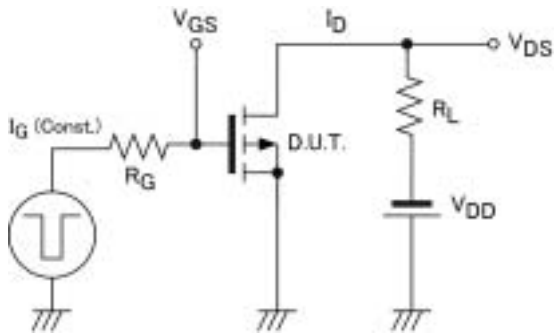


Fig.2-1 GATE CHARGE MASUREMENT CIRCUIT

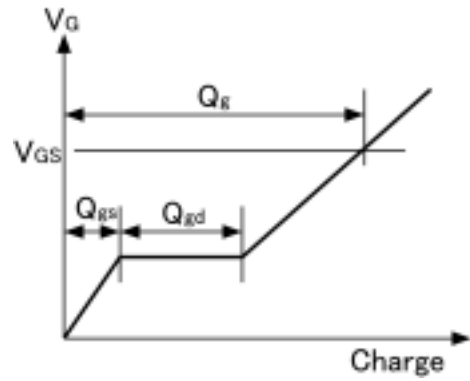


Fig.2-2 GATE CHARGE WAVEFORM